

**NPN 9 GHz wideband transistor****BFR540****FEATURES**

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

**DESCRIPTION**

The BFR540 is an npn silicon planar epitaxial transistor, intended for applications in the RF frontend in wideband applications in the GHz range, such as analog and digital cellular telephones, cordless telephones (CT1, CT2, DECT, etc.), radar detectors, satellite TV tuners (SATV), MATV/CATV amplifiers and repeater amplifiers in fibre-optic systems.

The transistor is encapsulated in a plastic SOT23 envelope.

**PINNING**

PIN	DESCRIPTION
Code: N29	
1	base
2	emitter
3	collector

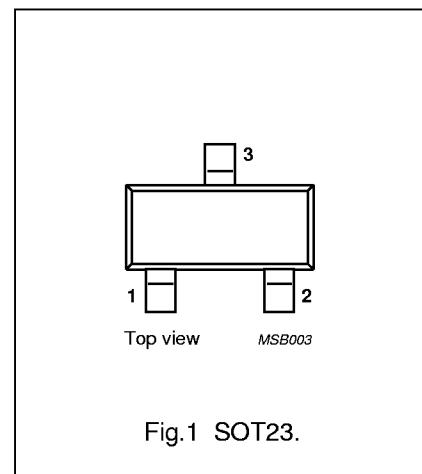


Fig.1 SOT23.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	—	—	20	V
$V_{CES}$	collector-emitter voltage	$R_{BE} = 0$	—	—	15	V
$I_C$	DC collector current		—	—	120	mA
$P_{tot}$	total power dissipation	up to $T_s = 70^\circ\text{C}$ ; note 1	—	—	500	mW
$h_{FE}$	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}$	60	120	250	
$C_{re}$	feedback capacitance	$I_C = i_c = 0; V_{CB} = 8 \text{ V}; f = 1 \text{ MHz}$	—	0.6	—	pF
$f_T$	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ GHz}$	—	9	—	GHz
$G_{UM}$	maximum unilateral power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	14	—	dB
		$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 2 \text{ GHz}$	—	7	—	dB
$ S_{21} ^2$	insertion power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	12	13	—	dB
$F$	noise figure	$\Gamma_s = \Gamma_{opt}; I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	1.3	1.8	dB
		$\Gamma_s = \Gamma_{opt}; I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	1.9	2.4	dB
		$\Gamma_s = \Gamma_{opt}; I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 2 \text{ GHz}$	—	2.1	—	dB

**Note**

1.  $T_s$  is the temperature at the soldering point of the collector tab.

## NPN 9 GHz wideband transistor

BFR540

**LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	20	V
$V_{CES}$	collector-emitter voltage	$R_{BE} = 0$	–	15	V
$V_{EBO}$	emitter-base voltage	open collector	–	2.5	V
$I_C$	DC collector current		–	120	mA
$P_{tot}$	total power dissipation	up to $T_s = 70^\circ\text{C}$ ; note 1	–	500	mW
$T_{stg}$	storage temperature		–65	150	$^\circ\text{C}$
$T_j$	junction temperature		–	175	$^\circ\text{C}$

**THERMAL RESISTANCE**

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{thj-s}$	from junction to soldering point	see note 1	260 K/W

**Note**

1.  $T_s$  is the temperature at the soldering point of the collector tab.

## NPN 9 GHz wideband transistor

BFR540

**CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CBO}$	collector cut-off current	$I_E = 0; V_{CB} = 8 \text{ V}$	—	—	50	nA
$h_{FE}$	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}$	60	120	250	
$C_e$	emitter capacitance	$I_C = i_c = 0; V_{EB} = 0.5 \text{ V}; f = 1 \text{ MHz}$	—	2	—	pF
$C_c$	collector capacitance	$I_E = i_e = 0; V_{CB} = 8 \text{ V}; f = 1 \text{ MHz}$	—	0.9	—	pF
$C_{re}$	feedback capacitance	$I_C = 0; V_{CB} = 8 \text{ V}; f = 1 \text{ MHz}$	—	0.6	—	pF
$f_T$	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ GHz}$	—	9	—	GHz
$G_{UM}$	maximum unilateral power gain (note 1)	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	14	—	dB
		$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 2 \text{ GHz}$	—	7	—	dB
$ S_{21} ^2$	insertion power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	12	13	—	dB
F	noise figure	$\Gamma_s = \Gamma_{opt}; I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	1.3	1.8	dB
		$\Gamma_s = \Gamma_{opt}; I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	1.9	2.4	dB
		$\Gamma_s = \Gamma_{opt}; I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}; f = 2 \text{ GHz}$	—	2.1	—	dB
$P_{L1}$	output power at 1 dB gain compression	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; R_L = 50 \Omega; T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz}$	—	21	—	dBm
ITO	third order intercept point	note 2	—	34	—	dBm
$V_o$	output voltage (note 3)	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; Z_L = Z_S = 75 \Omega; T_{amb} = 25^\circ\text{C}$	—	550	—	mV

**Notes**

1.  $G_{UM}$  is the maximum unilateral power gain, assuming  $S_{12}$  is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} \text{ dB.}$$

2.  $I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; R_L = 50 \Omega;$   
 $T_{amb} = 25^\circ\text{C}; f = 900 \text{ MHz};$   
 $f_p = 900 \text{ MHz}; f_q = 902 \text{ MHz};$   
measured at  $f_{(2p-q)} = 898 \text{ MHz}$  and  $f_{(2q-p)} = 904 \text{ MHz}$ .

3.  $d_{im} = -60 \text{ dB}$  (DIN 45004B);  
 $V_p = V_O; V_q = V_O - 6 \text{ dB}; f_p = 795.25 \text{ MHz};$   
 $V_R = V_O - 6 \text{ dB}; f_q = 803.25 \text{ MHz}; f_t = 805.25 \text{ MHz};$   
measured at  $f_{(p+q-t)} = 793.25 \text{ MHz}$ ; preliminary data.

## NPN 9 GHz wideband transistor

BFR540

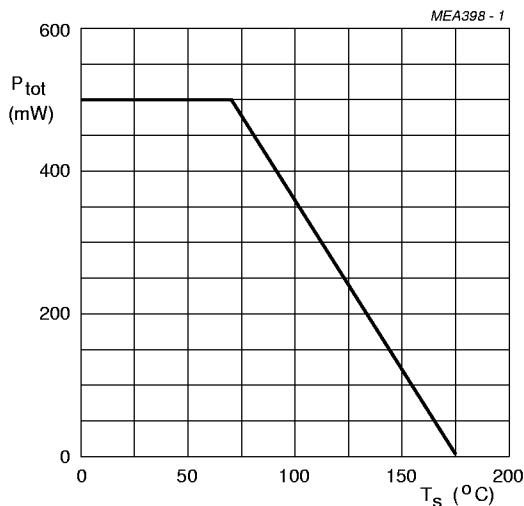


Fig.2 Power derating curve.

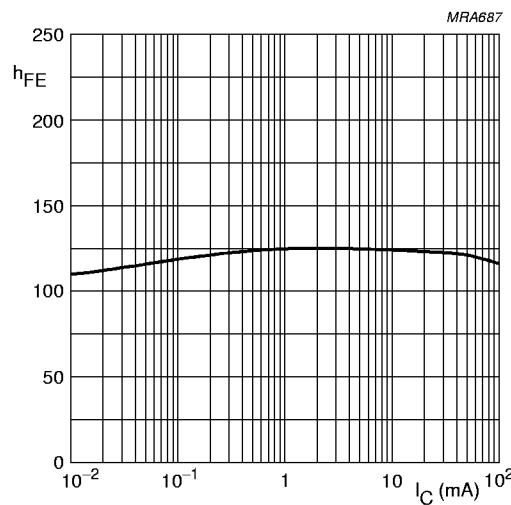
 $V_{CE} = 8$  V.

Fig.3 DC current gain as a function of collector current.

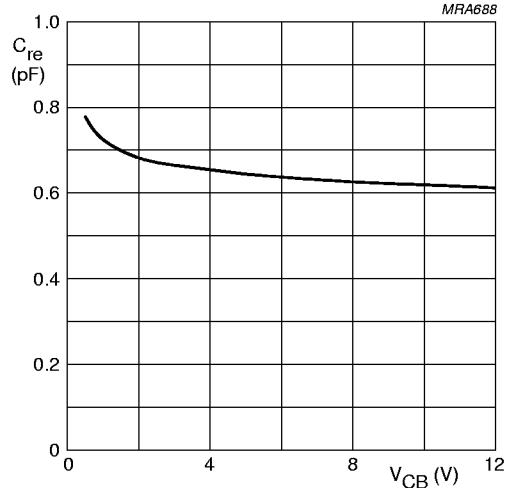
 $I_C = 0$ ;  $f = 1$  MHz.

Fig.4 Feedback capacitance as a function of collector-base voltage.

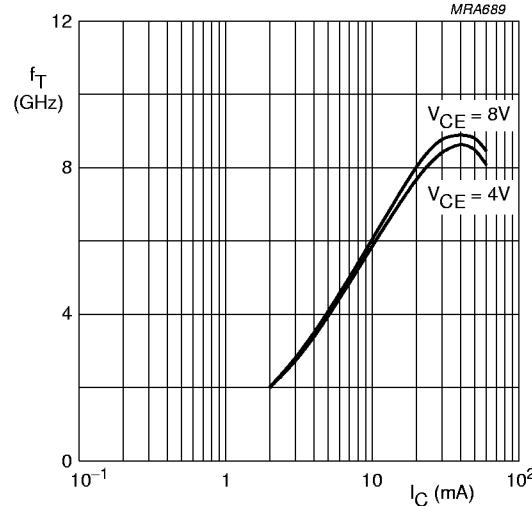
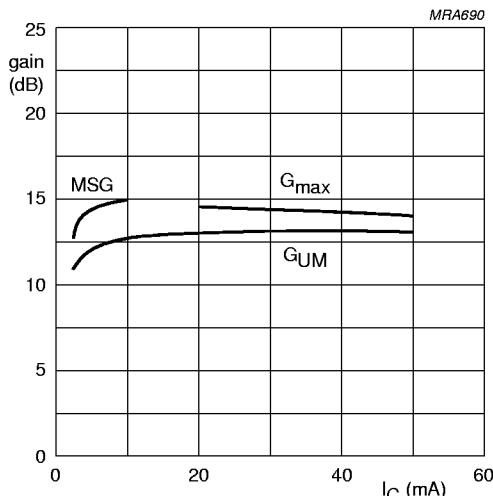
 $T_{amb} = 25$   $^{\circ}$ C;  $f = 1$  GHz.

Fig.5 Transition frequency as a function of collector current.

## NPN 9 GHz wideband transistor

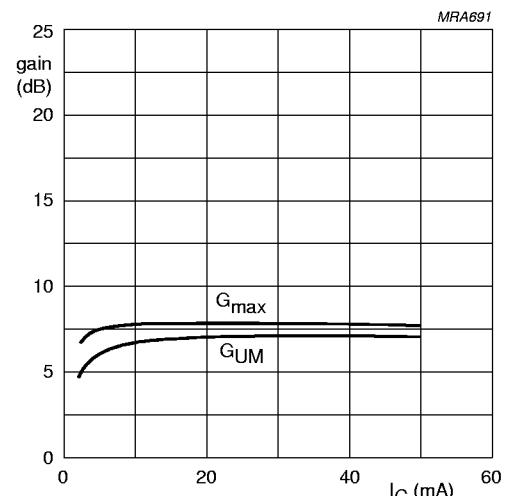
BFR540

In Figs 6 to 9,  $G_{UM}$  = maximum unilateral power gain; MSG = maximum stable gain;  $G_{max}$  = maximum available gain.



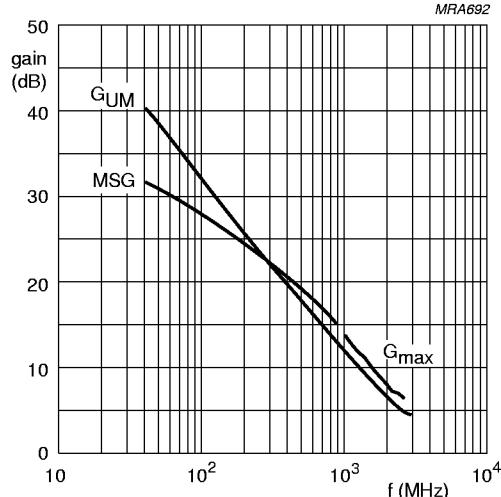
$V_{CE} = 8$  V;  $f = 900$  MHz.

Fig.6 Gain as a function of collector current.



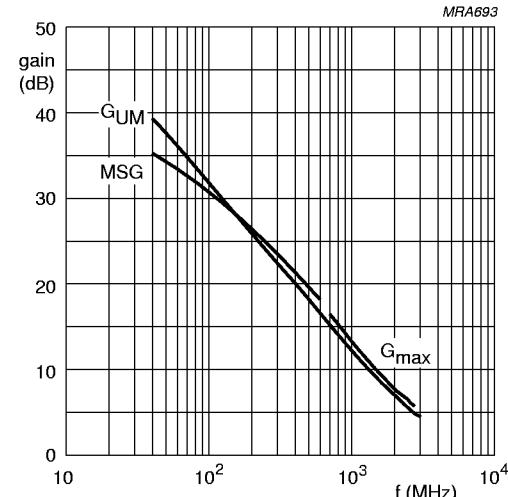
$V_{CE} = 8$  V;  $f = 2$  GHz.

Fig.7 Gain as a function of collector current.



$V_{CE} = 8$  V;  $I_c = 10$  mA.

Fig.8 Gain as a function of frequency.



$V_{CE} = 8$  V;  $I_c = 40$  mA.

Fig.9 Gain as a function of frequency.

## NPN 9 GHz wideband transistor

BFR540

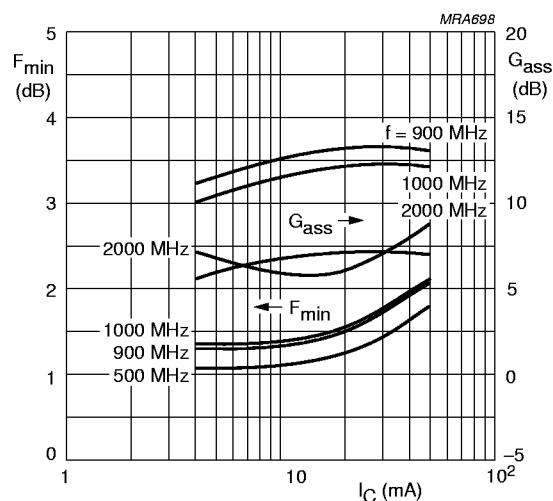
 $V_{CE} = 8 \text{ V}$ .

Fig.10 Minimum noise figure and associated available gain as functions of collector current.

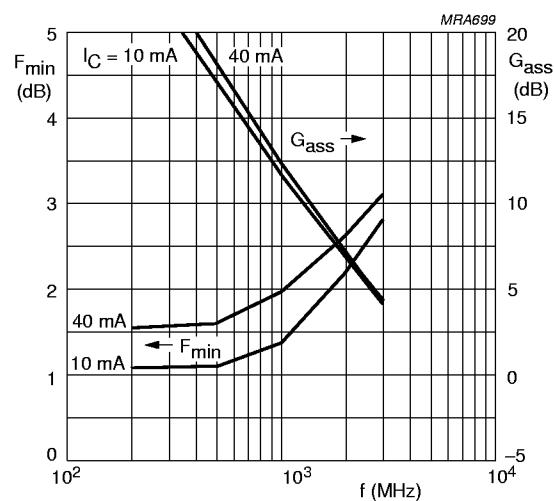
 $V_{CE} = 8 \text{ V}$ .

Fig.11 Minimum noise figure and associated available gain as functions of frequency.

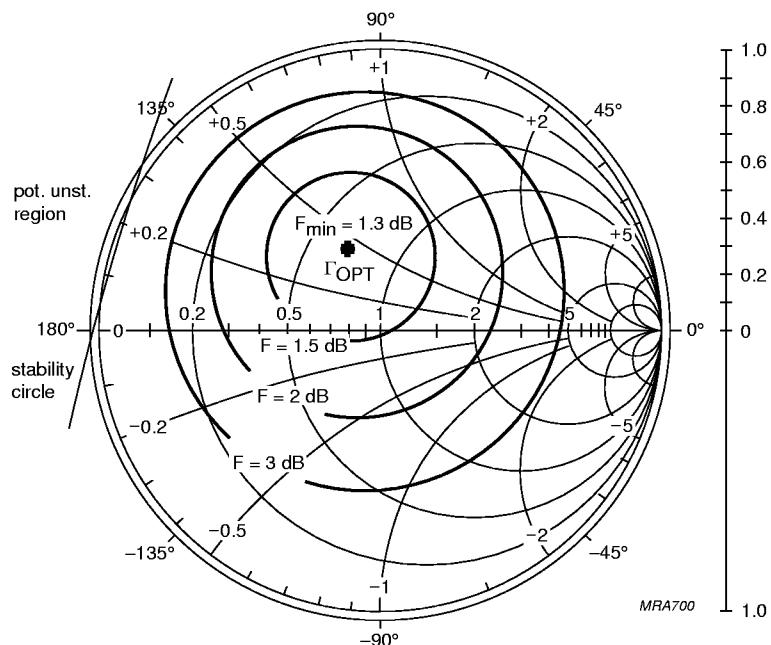
 $Z_o = 50 \Omega$ . $V_{CE} = 8 \text{ V}; I_C = 10 \text{ mA}; f = 900 \text{ MHz}$ .

Fig.12 Noise circle figure.

## NPN 9 GHz wideband transistor

BFR540

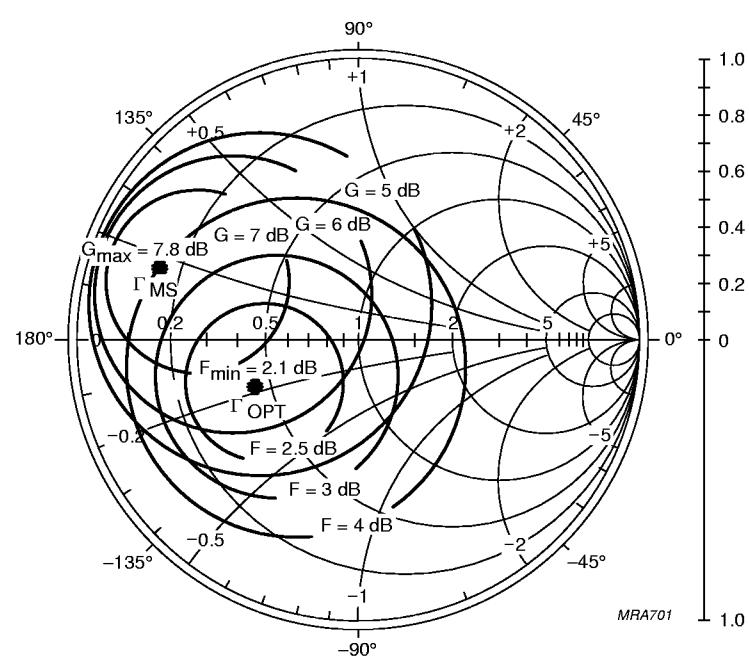
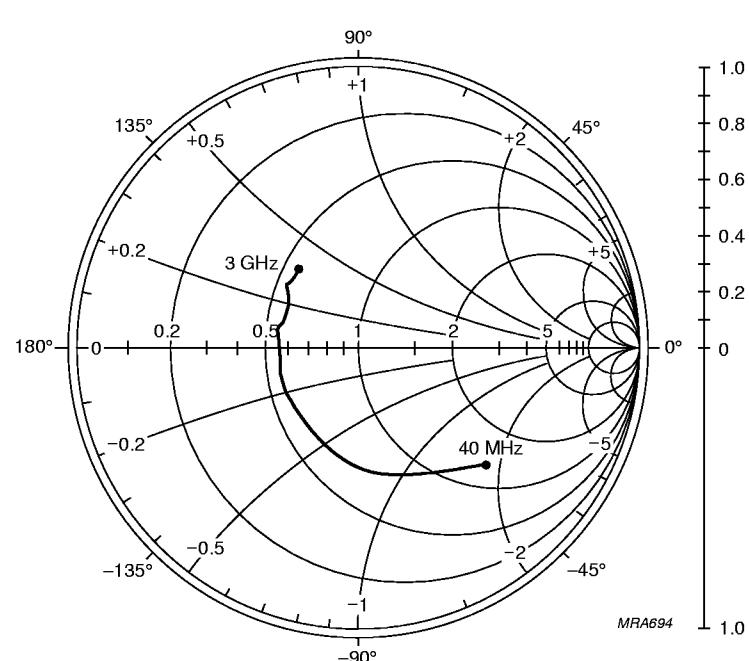
 $Z_o = 50 \Omega$ . $V_{CE} = 8 \text{ V}; I_C = 10 \text{ mA}; f = 2000 \text{ MHz}$ .

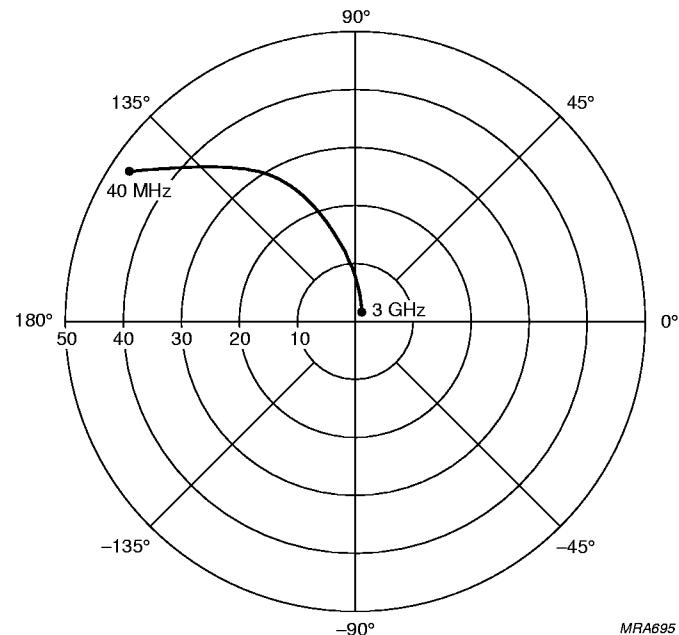
Fig.13 Noise circle figure.

## NPN 9 GHz wideband transistor

BFR540



$V_{CE} = 8 \text{ V}; I_C = 40 \text{ mA}.$   
 $Z_o = 50 \Omega.$

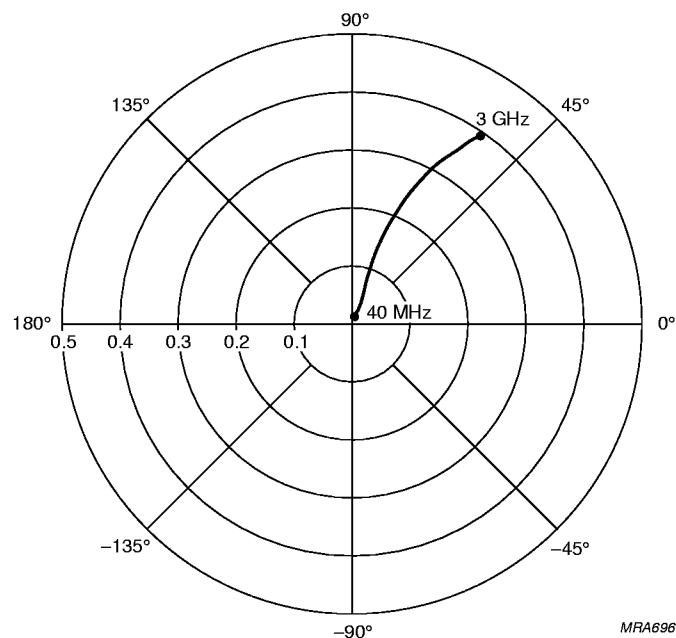
Fig.14 Common emitter input reflection coefficient ( $S_{11}$ ).

$V_{CE} = 8 \text{ V}; I_C = 40 \text{ mA}.$

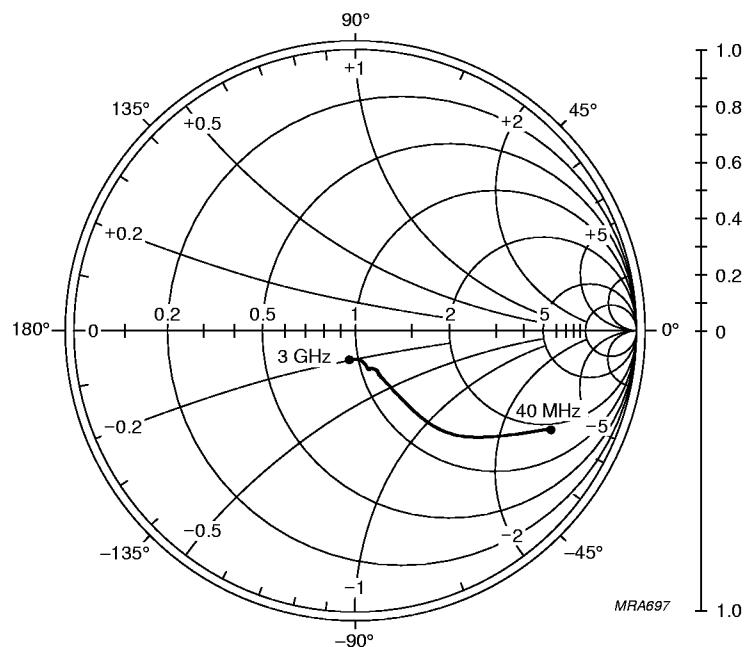
Fig.15 Common emitter forward transmission coefficient ( $S_{21}$ ).

## NPN 9 GHz wideband transistor

BFR540



MRA696

 $V_{CE} = 8 \text{ V}; I_C = 40 \text{ mA}.$ Fig.16 Common emitter reverse transmission coefficient ( $S_{12}$ ).

MRA697

 $V_{CE} = 8 \text{ V}; I_C = 40 \text{ mA}.$   
 $Z_0 = 50 \Omega.$ Fig.17 Common emitter output reflection coefficient ( $S_{22}$ ).

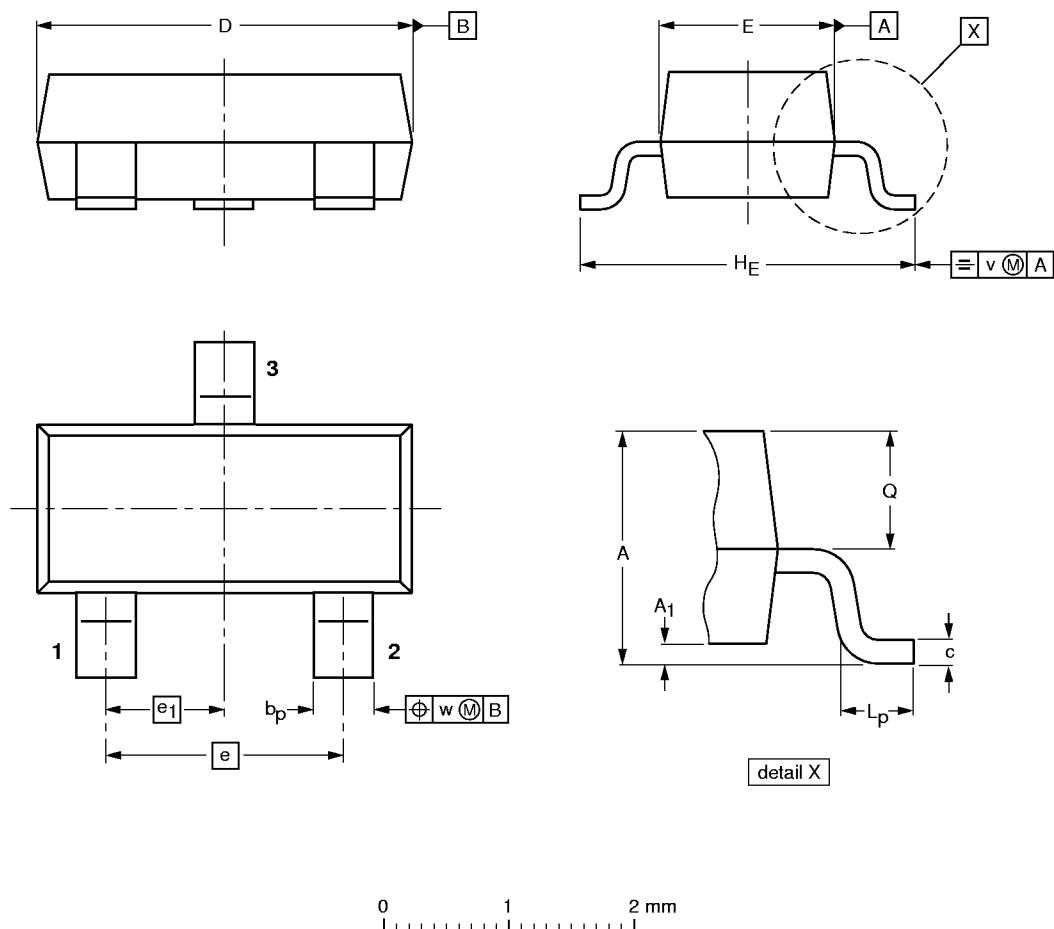
## NPN 9 GHz wideband transistor

BFR540

## PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



## DIMENSIONS (mm are the original dimensions)

UNIT	A	$A_1$ max.	$b_p$	c	D	E	e	$e_1$	$H_E$	$L_p$	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23						97-02-28